

# **CONAN®**

# High Density, Low Profile 1.00mm Pitch Mezzanine Connectors

### I - Series for Industrial Electronics Applications and Harsh Environments



The Conan 1.0mm mezzanine connector system provides a mechanically secure, high density electrical interface between parallel printed circuit boards.

Conan's mechanical features and palladium/nickel/gold plated electrical contacts qualify it for high reliability use in durable electronic equipment and portable instruments.



#### **FEATURES & BENEFITS**

- "Snap" engagement contacts assure secure mating with an audible "click"
- Blade-on-beam contact design allows "peeling" disengagement and prevents contact stubbing
- Connector housings feature "lead-in" angles to assist in mating
- Surface mounted metal hold-downs reinforce connector retention to the printed circuit board
- Mating polarization prevents backward connections
- ▶ PCB polarization prevents errors during printed circuit board assembly
- ▶ Pick and place caps with tape and reel packaging support automated assembly processes
- ► Header height options support a range of PCB stack heights: 4.15mm to 7mm
- 9 part sizes: 9 to 69 contacts
- Lead-free RoHS compatible products satisfy environmental regulations

#### **TARGET MARKETS / APPLICATIONS**

- Industrial electronics
- Portable and mobile electronic equipment
- Motor vehicle
- ► Harsh Environments



# FCi

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#### **MATERIALS**

- Contact base metal
  - Header: Phosphor bronze
  - Receptacle: Copper Alloy, High Spring
- Contact area finish: 0.38um (15uin.) GXT (Palladiumnickel alloy with gold flash) over 1.27um (50uin.) nickel
- Solder area finish: Pure tin over 1.27um (50uin.) nickel
- Housing material: Cream-colored LCP (UL 94V-0)

#### **ELECTRICAL PERFORMANCE**

- Insulation resistance: 1000 M $\Omega$  min
- Contact resistance: 30 mΩ max
- Withstanding voltage: 500 V ac, rms, 60 Hz
- Current rating: 1.0 amp continuous (per contact, all contacts powered)
- Signal Integrity (differential pairs, connector only)
  - Impedance: 100Ω +/- 10% @ 50 ps edge (10-90%)
  - Insertion Loss: < 1dB to 5GHz
  - NEXT: ≤3.5% for a 50 ps edge (10-90%)
  - FEXT: ≤2.5% for a 50 ps edge (10-90%)

#### **MECHANICAL PERFORMANCE**

- ► Mating force: 125g per contact max
- Unmating force: 25g per contact min
- Retention force (connector to PCB): 44 N (10lbf) min
- Contact wipe: 0.64mm (0.025 in.)
- Durability: 30 mating cycles

#### **ENVIRONMENTAL PERFORMANCE**

- IMFG per Battle class 29 20 days mated
- ► High temperature life 105°C

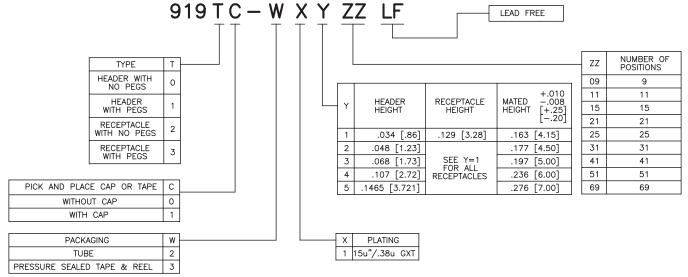
#### **SPECIFICATIONS**

**GS-12-006** 

#### **PACKAGING**

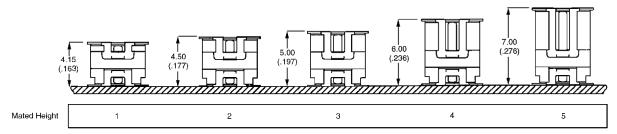
Anti-static tubes or tape and reel

#### PART NUMBERS



Recommended packaging combinations:

For production: Connector with pick and place cap packaged in tape and reel (XXXX1-3XXXX) For proto-typing: Connector without pick and place cap packaged in tubes (XXXX0-2XXXX) For commercial applications see print 10118744



Mated connector max.width: .220" (5.59mm)